General Information

Model 56610 is a member of the Cobalt® family of high-performance AMC boards based on the Xilinx Virtex-6 FPGA. This digital I/O board provides 32 LVDS differential inputs or outputs plus LVDS clock, data valid, and data flow control on a front panel 80-pin connector. Its built-in data capture and data generation feature offers an ideal turnkey solution as well as a platform for developing and deploying custom FPGA-processing IP.

In addition to supporting PCI Express Gen. 1 as a native interface, the Model 56610 includes a general-purpose connector for application-specific I/O.

The Cobalt Architecture

The Pentek Cobalt Architecture features a Virtex-6 FPGA. All of the board's data and control paths are accessible by the FPGA, enabling factory-installed functions for data flow and memory control. The Cobalt Architecture organizes the FPGA as a container for data processing applications where each function exists as an IP (intellectual property) module.

Each member of the Cobalt family is delivered with factory-installed applications ideally matched to the board's interface. The 56610 factory-installed functions include 32-bit acquisition and generation IP modules, to support either input or output functions, respectively.

IP modules for DDR3 SDRAM memories, a controller for all data clocking, a test signal generator, and a PCIe interface complete the factory-installed functions and enable the 56610 to operate as a complete turnkey solution without the need to develop any FPGA IP.

Extendable IP Design

For applications that require specialized function, users can install their own custom IP for data processing. Pentek GateFlow FPGA Design Kits include all of the factory-installed modules as documented source code. Developers can integrate their own IP with the Pentek factory-installed functions or use the GateFlow kit to completely replace the Pentek IP with their own.

Xilinx Virtex-6 FPGA

The Virtex-6 FPGA can be populated with a variety of different FPGAs to match the specific requirements of the processing task. Supported FPGAs include: LX130T LX240T, or SX315T. The SXT part features up to 1344 DSP48E slices and is ideal for modulation/demodulation, encoding/decoding, encryption/decryption, and channelization of the signals between transmission and reception. For applications not requiring large DSP resources, one of the lower-cost LXT FPGAs can be installed.

Option -104 installs a front panel connector with 20 pairs of LVDS connections to the FPGA for custom I/O. ➤

Features

- 32 bits of LVDS digital I/O
- One LVDS clock
- One LVDS data valid
- One LVDS data suspend
- Supports LXT and SXT Virtex-6 FPGAS
- DMA controller moves data to and from system memory
- Up to 2 GB of DDR3 SDRAM
- PCI Express interface
- AMC.1 compliant
- IPMI 2.0 compliant MMC (Module Management Controller)
- Optional LVDS connections to the Virtex-6 FPGA for custom I/O to the carrier board
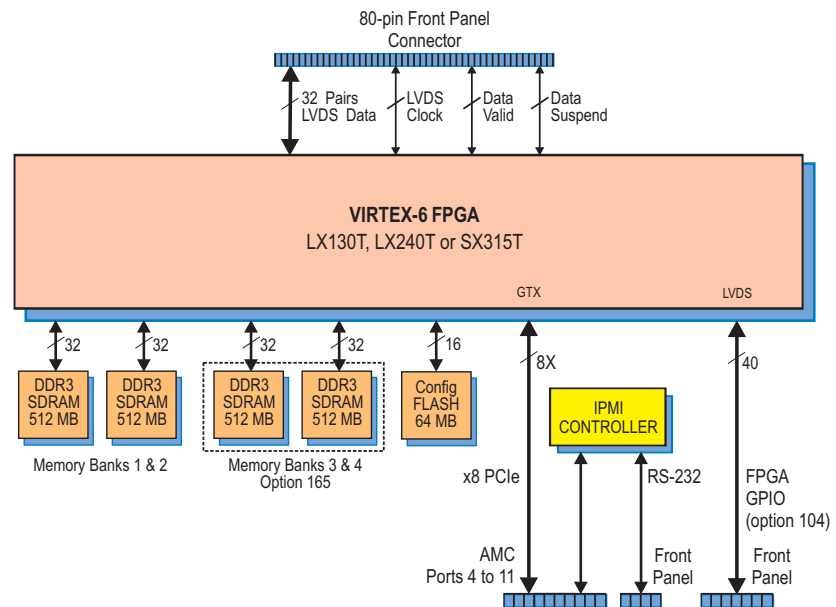
➤ Acquisition IP Module

The board can be configured for digital input mode by the setting of a jumper. In this case, the board accepts input data Clock and input data Valid signals. This supports a continuous input Clock with data accepted only when the Data Valid line is true. The board can optionally generate a Data Suspend output signal indicating that the 56610 is no longer capable of accepting data. The board accepts 32 bits from the front panel connector or from an on-board test signal generator.

Each IP module has an associated memory bank for buffering data in FIFO mode or for storing data in transient capture mode. Memory banks are supported with DMA engines for easily moving input data through the PCIe interface.

Generation IP Module

The board can be configured for digital output mode by the setting of a jumper. In this case, the board generates output data Clock and output Data Valid signals. This supports a continuous output Clock with data valid only when the Data Valid line is true. The board can optionally accept a Data Suspend input signal to halt data generation when the destination device is no longer capable of accepting data.

A linked-list controller allows users to generate 32-bit digital words out through the front panel LVDS connector from tables stored in either on-board or off-board host memory. Parameters including length of table, delay from software trigger, table repetition, etc. can be programmed for entry. Up to 64 individual link entries can be chained together to create complex output patterns with minimum programming.

AMC Interface

The Model 56610 complies with the AMC.1 specification by providing an x8 PCIe connection to AdvancedTCA carriers or µTCA chassis. Module management is provided by an IPMI 2.0 MMC (Module Management Controller).

PCI Express Interface

The Model 56610 includes an industry-standard interface fully compliant with PCI Express Gen. 1 bus specifications. Supporting a PCIe x4 or x8 connection, the interface includes multiple DMA controllers for efficient transfers to and from the board.

Memory Resources

The 56610 hardware architecture supports up to four independent 512 MB memory banks of DDR3 SDRAM. The board is always configured with 1 GB of memory (Banks 1 and 2).

In addition to the factory-installed functions, custom user-installed IP within the FPGA can take advantage of the memories for many other purposes. For customers who need more memory to support their IP, Banks 3 and 4 can be optionally added for a total of 2 GB of DDR3 SDRAM

Specifications

Front Panel Input/Output
    Data Lines: 35 LVDS differential pairs (32 pairs supported in factory-installed functions), 2.5 V compliant
    Clock: One LVDS differential pair, 2.5 V compliant
    Data Valid: One LVDS differential pair, 2.5 V compliant
    Data Suspend: One LVDS differential pair, 2.5 V compliant

Field Programmable Gate Array
    Standard: Xilinx Virtex-6 XC6VLX130T
    Optional: Xilinx Virtex-6 XC6VLX240T, or XC6VSX315T

Custom I/O
    Option -104: Installs a front panel connector with 20 LVDS pairs to the FPGA

Memory
    Standard: Two 512 MB DDR3 SDRAM memory banks (1 and 2), 400 MHz DDR
    Option 165: Two 512 MB DDR3 SDRAM memory banks (3 and 4), 400 MHz DDR

AMC Interface
    Type: AMC.1
    Module Management: IPMI Version 2.0

PCI-Express Interface
    PCI Express Bus: Gen. 1: x4 or x8

Environmental
    Operating Temp: 0° to 50° C
    Storage Temp: –20° to 90° C
    Relative Humidity: 0 to 95%, non-cond.

Size: Single-width, full-height AMC module, 2.89 in. x 7.11 in.

Ordering Information

Model Description

56610	LVDS Digital I/O with Virtex-6 FPGA - PCIe

Options:

-062	XC6VLX240T
-064	XC6VSX315T
-104	LVDS FPGA I/O through 68-pin ribbon cable connector
-105	Gigabit serial FPGA I/O through two 4X top edge connectors
-155*	Two 512 MB DDR3 SDRAM Memory Banks (Banks 1 and 2)
-165	Two 512 MB DDR3 SDRAM Memory Banks (Banks 3 and 4)

* This option is always required

Contact Pentek for availability of rugged and conduction-cooled versions

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